# **TL751X chip PDF download**

# Main features of TL751X:

### **High performance:**

Supports 24bit/768kHz Codec.

RF sensitivity and transmission power are better than previous generations of audio chips.

### **Multi-protocol:**

Supports multiple protocols such as 2.4GHz, BT, LE Audio, including BLE, Bluetooth 5.4 and its subsequent versions, as well as Mesh, Thread, 802.15.4, Zigbee 3.1, HomeKit, Matter and other protocols.

#### Multi-mode online:

Supports dual-mode online (such as 2.4GHz + BT or 2.4GHz + LE Audio), and supports three-mode online (such as BT + LE Audio + 2.4GHz private protocol) when hardware, performance and computing power are stronger.

#### **High integration:**

Multi-core processor, built-in 3 cores (2 RISC-V and 1 HiFi 5 DSP), the main frequency can reach 300MHz.

Provides a rich set of peripheral interfaces, including I2S, I2C, OSPI/QSPI, S/PDIF, EMMC, SDIO, etc.

# Advantages and features of TL751X:

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### **Multi-protocol:**

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#### Multi-mode online:

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Third-party platform support: Supports third-party operating system platforms such as Open Thread, Zephyr, FreeRTOS, Hongmeng OS, Ali OS, etc.

#### **High performance:**

Supports 24bit/768kHz Codec. The performance of ADC and DAC has been significantly improved, with the SNR of ADC reaching 106dB and THD+N reaching 80dB; the SNR of DAC reaching 120dB and THD+N reaching 90dB.

Supports 6-channel MIC input and stereo output, which can be configured as 6-channel D MIC or 4-channel A MIC plus 2-channel D MIC. The transmit power can reach 13 dBm in GFSK mode and 10 dBm in EDR2 mode.

The RF sensitivity can reach -98dBm in BLE mode, -102dBm in 802.15.4 mode, and -94dBm in EDR 2Mbps mode.

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### **High integration:**

Multi-core processor, built-in 3 cores (2 RISC-V and 1 HiFi 5 DSP), the main frequency can reach 300MHz.

Rich peripheral interfaces, including OSPI/QSPI, SDIO2.0, EMMC5.1, USB 2.0, I2C\*2, UART\*4, I2S\*3, PWM\*6, etc.

# **About IoT Cloud Platform**

IoT Cloud Platform (blog.iotcloudplatform.com) focuses on IoT design, IoT programming, security IoT, industrial IoT, military IoT, IoT programming language, best IoT projects, IoT ideas, IoT companies, Chinese IoT companies, American IoT companies, top IoT companies, sensor factories, sensor equipment, IoT modules, embedded development, <u>loT circuit boards</u>, loT solutions, Raspberry Pi development, Arduino programming, Raspberry Pi programming design, RFID companies, lora devices, loT systems, agricultural loT sensors, temperature and humidity sensors, liquid level sensors, light sensors, sound sensors, artificial intelligence, AI development, AI robots, blockchain technology, simulation machines People, robotic arms, smart homes, smart cities, smart agriculture, smart factories, smart security, edge computing, big data, cloud computing, brain-computer interfaces, machine learning, deep learning, robots, VR/AR, AI simulation technology, motion control, material science and technology, machine

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